

D35XB80

Bridge Diodes
800V, 35A

Feature

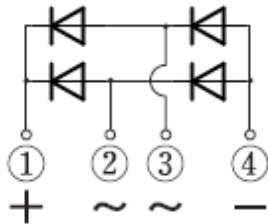
- Compact SIP
- UL E142422
- High Current
- High heat dissipation
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 5S



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 150	°C
Junction temperature	Tj		-55 to 150	°C
Repetitive peak reverse voltage	V _{RRM}		800	V
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, With heatsink, Tc=93°C	35	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C ※	3	A
Surge forward current	I _{FSM}	60Hz sine wave, Non-repetitive 1 cycle peak value, Tj=25°C	603	A
Surge forward current	I _{FSM}	50Hz sine wave, Non-repetitive 1 cycle peak value, Tj=25°C	550	A
Current squared time	I ² t	1ms≦tp<10ms, Tj=25°C, per diode	1512	A ² s
Dielectric strength	Vdis	Terminals to case backside, AC 1 minute	2.5	kV
Mounting torque	TOR	(Recommended torque : 0.5N・m)	0.8	N・m

※ : See the original Specifications

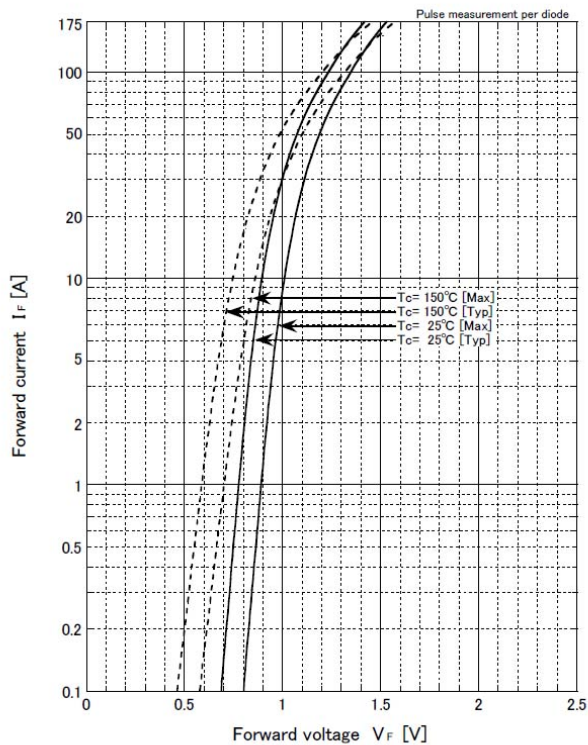
Electrical Characteristics (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=17.5A, Pulse measurement, per diode			1.05	V
Reverse current	I_R	VR=800V, Pulse measurement, per diode			10	μA
Reverse recovery time	trr	IF=0.1A, IR=0.1A, 0.1IRP, per diode			27000	ns
Thermal resistance	Rth(j-c)	Junction to case, With heatsink			0.8	°C/W
Thermal resistance	Rth(j-l)	Junction to lead, Without heatsink, On glass-epoxy substrate ※			5.2	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, Without heatsink, On glass-epoxy substrate ※			25	°C/W

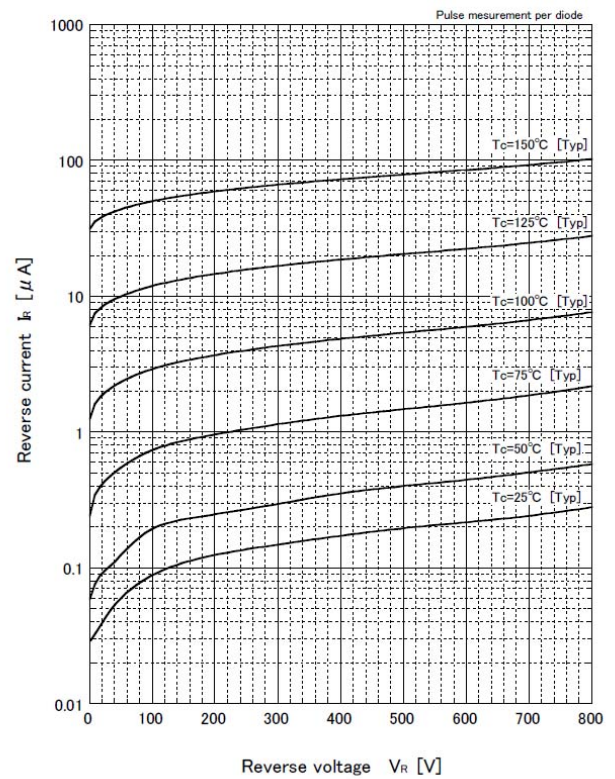
※ : See the original Specifications

CHARACTERISTIC DIAGRAMS

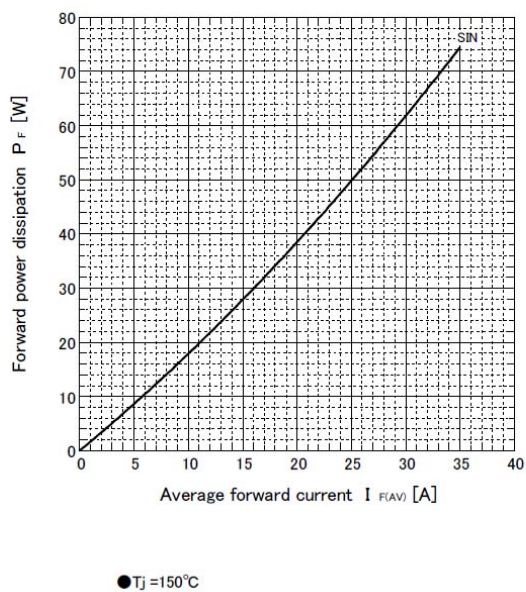
Forward voltage



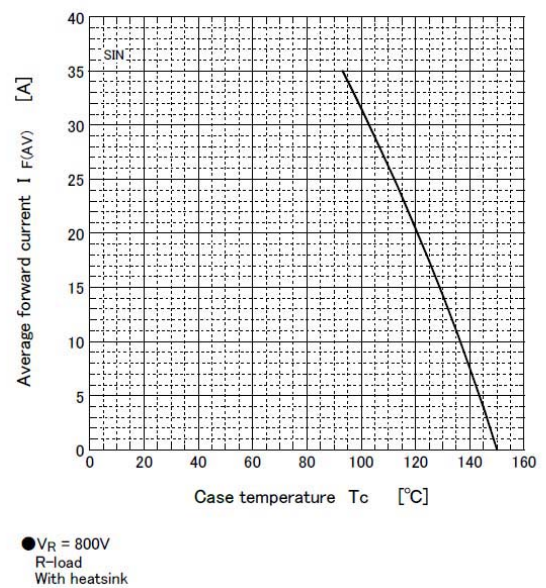
Reverse current



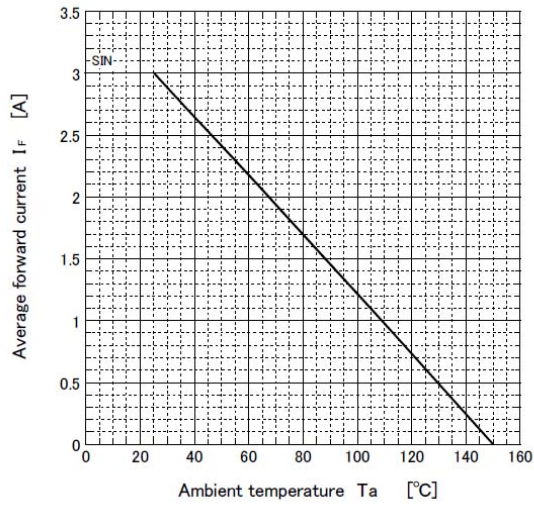
Forward power dissipation



Derating curve



Derating curve

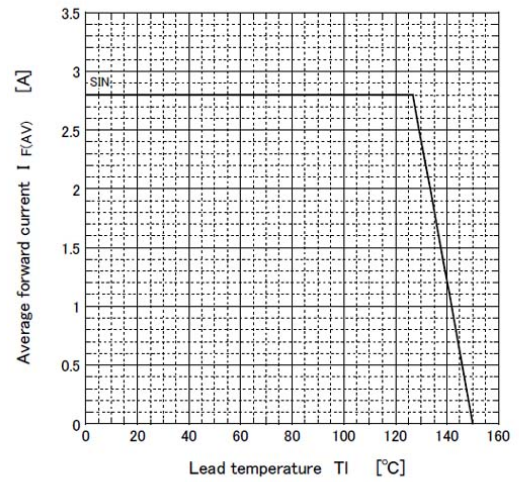


● $V_R = 800V$
R-load
Free in air

● Substrate detail

Type	Glass-epoxy
Size	90mm × 150mm
Thickness	1mm
Conductor thickness	35 μm
Pattern area	1107mm ²

Derating curve

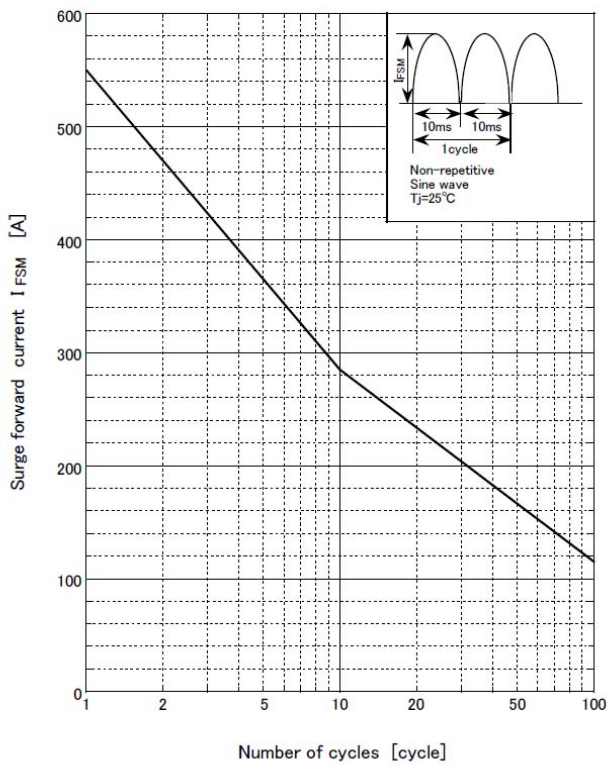


● $V_R = 800V$
R-load
Free in air

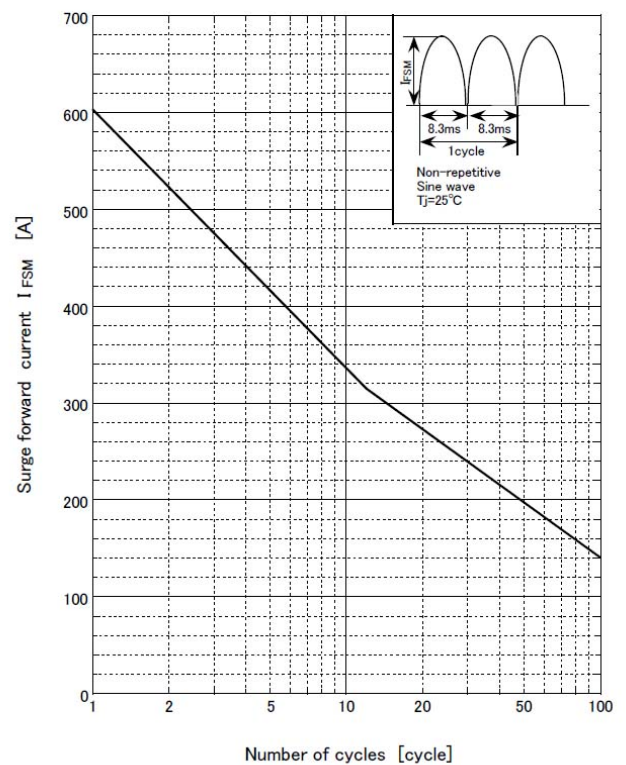
● Substrate detail

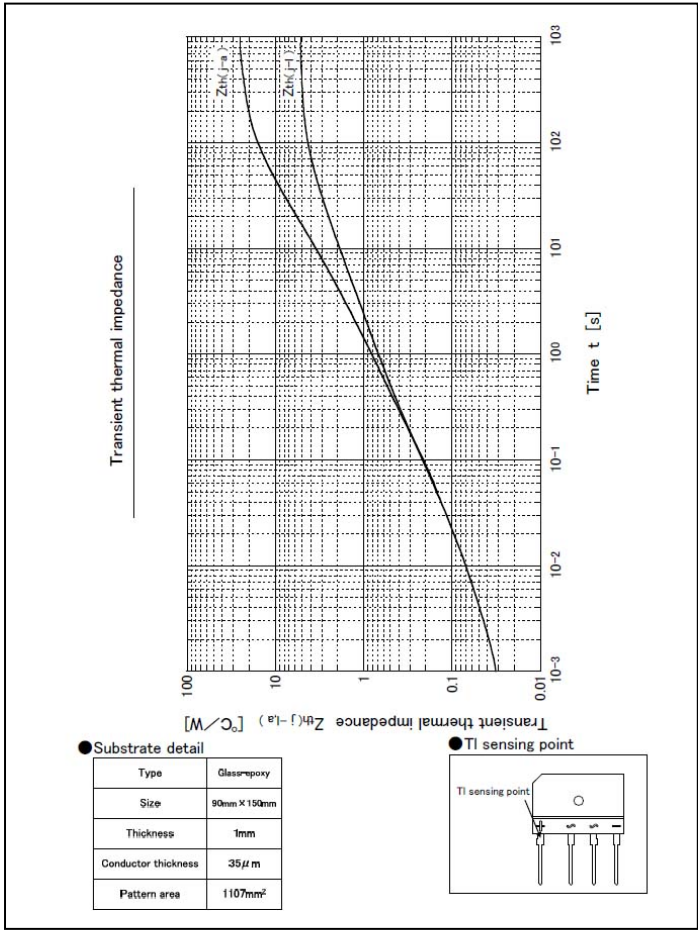
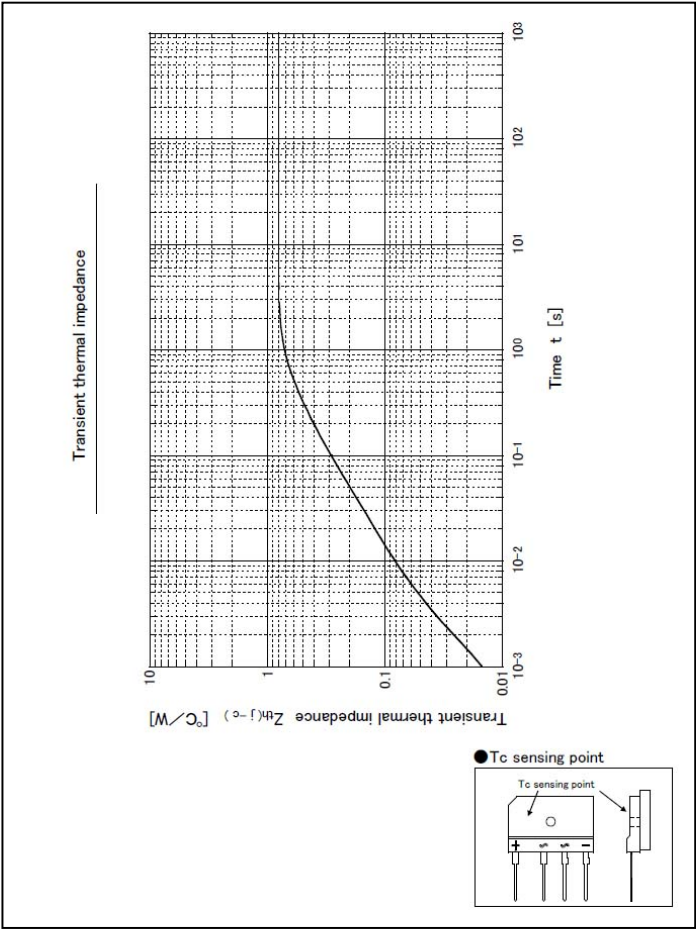
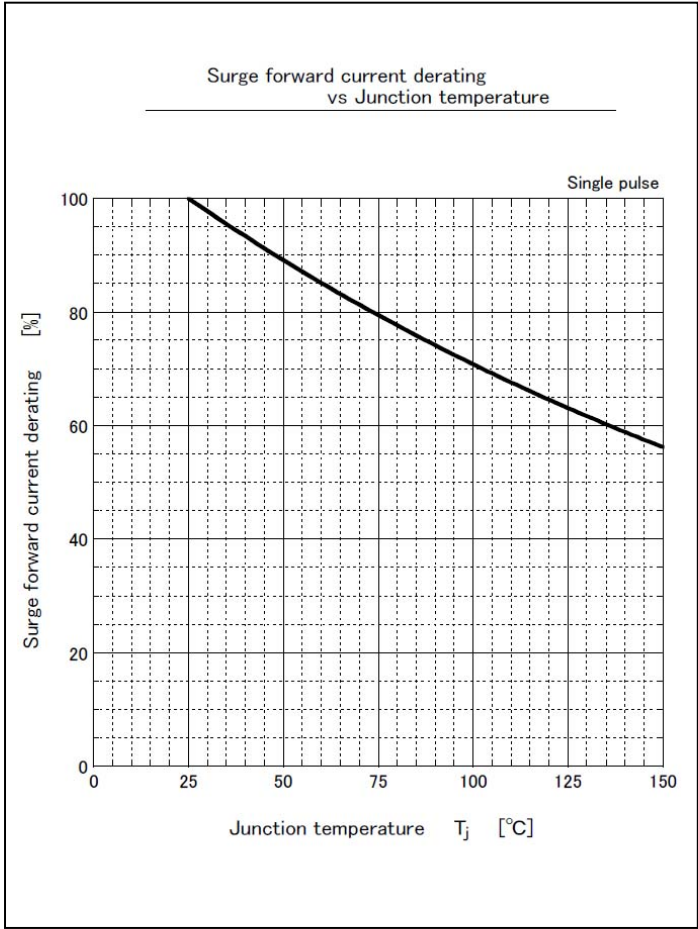
Type	Glass-epoxy
Size	90mm × 150mm
Thickness	1mm
Conductor thickness	35 μm
Pattern area	1107mm ²

Surge forward current capability



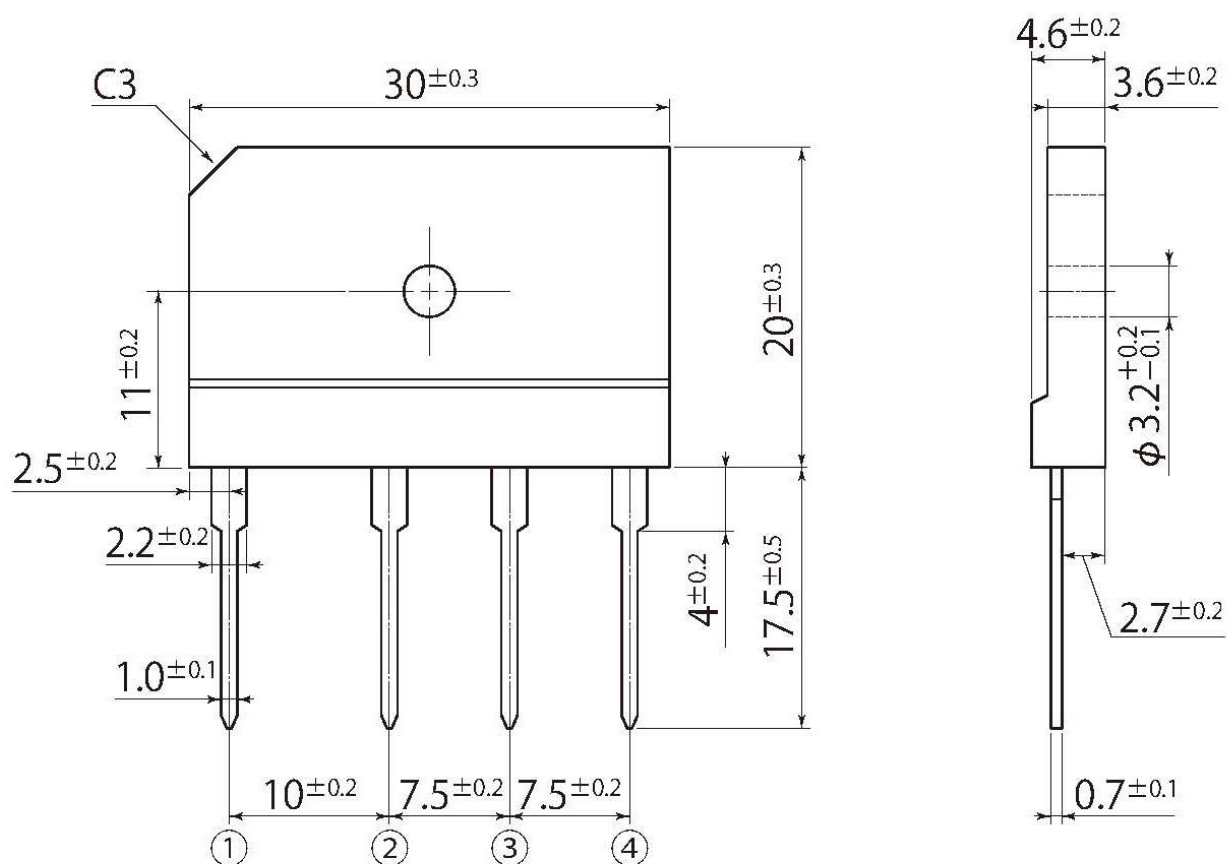
Surge forward current capability





D4

JEDEC Code	—
JEITA Code	—
House Name	5S



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